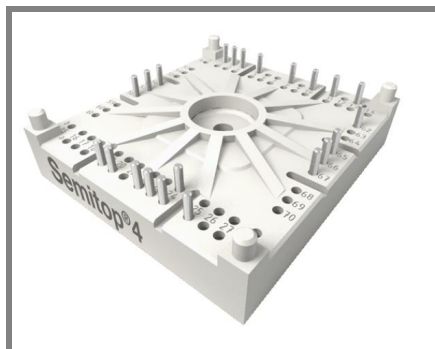


SK100GD126T



SEMITOP® 4

IGBT Module

SK100GD126T

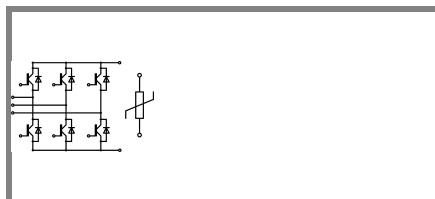
Target Data

Features

- One screw mounting module
- Fully compatible with SEMITOP®1,2,3
- Improved thermal performances by aluminium oxide substrate
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

Typical Applications

- Inverter up to 50 kVA
- Typ. motor power 22 kW

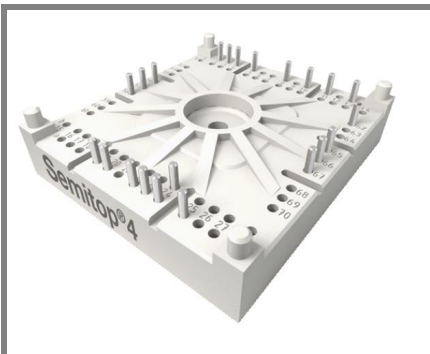


GD-T

Absolute Maximum Ratings		$T_s = 25\text{ °C}$, unless otherwise specified		
Symbol	Conditions	Values		Units
IGBT				
V_{CES}	$T_j = 25\text{ °C}$	1200		V
I_C	$T_j = 150\text{ °C}$	$T_s = 25\text{ °C}$	114	A
		$T_s = 70\text{ °C}$	86	A
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$	200		A
V_{GES}		± 20		V
t_{psc}	$V_{CC} = 600\text{ V}; V_{GE} \leq 20\text{ V}; T_j = 125\text{ °C}$ $V_{CES} < 1200\text{ V}$	10		µs
Inverse Diode				
I_F	$T_j = 150\text{ °C}$	$T_s = 25\text{ °C}$	118	A
		$T_s = 70\text{ °C}$	88	A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$	200		A
Module				
$I_{t(RMS)}$				A
T_{vj}		-40 ... +150		°C
T_{stg}		-40 ... +125		°C
V_{isol}	AC, 1 min.	2500		V

Characteristics		$T_s = 25\text{ °C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 4\text{ mA}$	5	5,8	6,5	V
I_{CES}	$V_{GE} = 0\text{ V}, V_{CE} = V_{CES}$	$T_j = 25\text{ °C}$			mA
		$T_j = 125\text{ °C}$			mA
I_{GES}	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}$	$T_j = 25\text{ °C}$	1200		nA
		$T_j = 125\text{ °C}$			nA
V_{CE0}		$T_j = 25\text{ °C}$	1	1,2	V
		$T_j = 125\text{ °C}$	0,9	1,1	V
r_{CE}	$V_{GE} = 15\text{ V}$	$T_j = 25\text{ °C}$	7	9,5	mΩ
		$T_j = 125\text{ °C}$	11	14	mΩ
$V_{CE(sat)}$	$I_{Cnom} = 100\text{ A}, V_{GE} = 15\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	1,7	2,15	V
		$T_j = 125\text{ °C}_{chiplev.}$	2,1	2,45	V
C_{ies}	$V_{CE} = 25, V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	7,2		nF
C_{oes}			0,37		nF
C_{res}			0,32		nF
$t_{d(on)}$	$R_{Gon} = 4\text{ }\Omega$ $di/dt = 2250\text{ A}/\mu\text{s}$	$V_{CC} = 600\text{ V}$ $I_{Cnom} = 100\text{ A}$	115		ns
t_r			28		ns
E_{on}	$R_{Goff} = 4\text{ }\Omega$ $di/dt = 2250\text{ A}/\mu\text{s}$	$T_j = 125\text{ °C}$ $V_{GE} = -7/+15\text{ V}$	9,2		mJ
$t_{d(off)}$			509		ns
t_f			100		ns
E_{off}			12,6		mJ
$R_{th(j-s)}$	per IGBT	0,4		K/W	

SK100GD126T



SEMITOP® 4

IGBT Module

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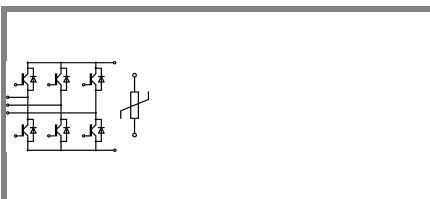
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Typical Applications

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GD-T

Characteristics		min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 100 \text{ A}; V_{GE} = 0 \text{ V}$		1		V
	$T_j = 25 \text{ }^\circ\text{C}_{\text{chiplev.}}$				
	$T_j = 125 \text{ }^\circ\text{C}_{\text{chiplev.}}$		1,5		V
V_{F0}			1,18		V
	$T_j = 25 \text{ }^\circ\text{C}$				
	$T_j = 125 \text{ }^\circ\text{C}$		1		V
r_F			3,2		mΩ
	$T_j = 25 \text{ }^\circ\text{C}$				
	$T_j = 125 \text{ }^\circ\text{C}$		5		mΩ
I_{RRM}	$I_{Fnom} = 100 \text{ A}$		100		A
Q_{rr}	$di/dt = 2250 \text{ A}/\mu\text{s}$		20		μC
E_{rr}	$V_{CC} = 600\text{V}$		7,3		mJ
$R_{th(j-s)D}$	per diode		0,55		K/W
M_s	to heat sink			3,5	Nm
w			60		g
Temperature sensor					
R_{100}	$T_s = 100^\circ\text{C} (R_{25}=5\text{k}\Omega)$		493±5%		Ω

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.

